



FCI7N60 600V N-Channel MOSFET

Features

- 650V @T_J = 150°C
- Typ. R_{DS(on)} = 0.53Ω
- Ultra Low Gate Charge (typ. Q_g = 25nC)
- Low Effective Output Capacitance (typ. Cosseff. = 60pF)
- 100% Avalanche Tested
- RoHS Compliant



Description

SuperFETTM is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.



Absolute Maximum Ratings

Symbol	Parameter			FCI7N60	Unit
V _{DSS}	Drain-Source Voltage			600	V
ID		ontinuous (T _C = 25°C) ontinuous (T _C = 100°C)		7 4.4	A A
I _{DM}	Drain Current - Pu	llsed	(Note 1)	21	A
V _{GSS}	Gate-Source voltage			± 30	V
E _{AS}	Single Pulsed Avalanche Energy		Note 2)	230	mJ
I _{AR}	Avalanche Current		Note 1)	7	А
E _{AR}	Repetitive Avalanche Energy (N		Note 1)	8.3	mJ
dv/dt	Peak Diode Recovery dv/d	t (Note 3)	4.5	V/ns
P _D		= 25°C) erate above 25°C		83 0.67	W W/°C
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

Symbol	Parameter	FCI7N60	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case	1.5	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	62.5	°C/W

Device Marking Dev		Device	vice Pa		ckage Reel Size Tape		e Width		Quantity 50	
FCI7I	0		l ²	-PAK						
Electric	al Char	racteristics T _c	= 25°C unle	ess otherwise no	ted					
Symbol		Parameter		1	Conditions		Min	Тур	Max	Units
Off Charac	teristics									
BV _{DSS}	BV _{DSS} Drain-Source Breakdown Voltage		V_{GS} = 0V, I _D = 250µA, T _J = 25°C			600			V	
			V_{GS} = 0V, I _D = 250µA, T _J = 150°C				650		V	
ΔBV _{DSS} / ΔT _J		Breakdown Voltage Temperature Coefficient		$I_D = 250\mu A$, Referenced to $25^{\circ}C$				0.6		V/°C
BV _{DS}	Drain-Source Avalanche Breakdown Voltage		V _{GS} = 0V, I _D = 7A				700		V	
I _{DSS}	Zero Gate Voltage Drain Current		$V_{DS} = 600V, V_{GS} = 0V$ $V_{DS} = 480V, T_{C} = 125^{\circ}C$					1 10	μΑ μΑ	
I _{GSSF}	Gate-Bod	ody Leakage Current, Forward		$V_{GS} = 30V, V_{DS} = 0V$				100	nA	
I _{GSSR}	Gate-Bod	y Leakage Current, R	everse	$V_{GS} = -30V, V_{DS} = 0V$				-100	nA	
On Charac	teristics			•						
V _{GS(th)}	Gate Thre	eshold Voltage		$V_{DS} = V_{GS}$	_s , I _D = 250μA		3.0		5.0	V
R _{DS(on)}		atic Drain-Source n-Resistance		V _{GS} = 10V, I _D = 3.5A				0.53	0.6	Ω
9 _{FS}	Forward 1	Fransconductance		V _{DS} = 40V	′, I _D = 3.5A	(Note 4)		6		S
Dynamic C	haracteris	tics							•	
C _{iss}	Input Cap	nput Capacitance Dutput Capacitance		$V_{\rm DS}$ = 25V, $V_{\rm GS}$ = 0V,			710	920	pF	
C _{oss}	Output Ca			f = 1.0MHz				380	500	pF
C _{rss}	Reverse 7	Fransfer Capacitance						34		pF
C _{oss}	Output Capacitance		V _{DS} = 480V, V _{GS} = 0V, f = 1.0MHz				22	29	pF	
C _{oss} eff.	Effective	ffective Output Capacitance		V_{DS} = 0V to 400V, V_{GS} = 0V			60		pF	
Switching	Characteri	stics								
t _{d(on)}	Turn-On [Delay Time		$V_{DD} = 300V, I_D = 7A$ $R_G = 25\Omega$			35	80	ns	
t _r	Turn-On F	Rise Time					55	120	ns	
t _{d(off)}	Turn-Off	Delay Time					75	160	ns	
t _f	Turn-Off F	Fall Time				(Note 4, 5)		32	75	ns
Qg	Total Gate	e Charge		$V_{DS} = 480$ V, $I_D = 7$ A $V_{GS} = 10$ V			23	30	nC	
Q _{gs}	Gate-Sou	rce Charge					4.2	5.5	nC	
Q _{gd}	Gate-Drai	in Charge				(Note 4, 5)		11.5		nC
Drain-Sour	ce Diode (Characteristics and	Maximur	n Ratings					T	
I _S	Maximum Continuous Drain-Source Dioc		de Forward Current					7	Α	
I _{SM}	Maximum	Pulsed Drain-Source	Diode F	orward Curr	ent				21	Α
V _{SD}	Drain-Sou	urce Diode Forward V	oltage	V_{GS} = 0V,	-				1.4	V
t _{rr}	Reverse F	Recovery Time		$V_{GS} = 0V, I_S = 7A$ $dI_F/dt = 100A/\mu s$ (Note 4)				360		ns
Q _{rr}	Reverse F	Recovery Charge				-	4.5		μC	

NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. I_{AS} = 3.5A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}C$

3. I_{SD} \leq 7A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$

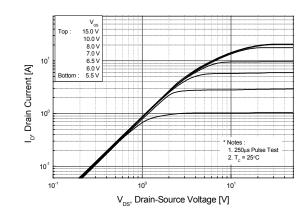
5. Essentially Independent of Operating Temperature Typical Characteristics

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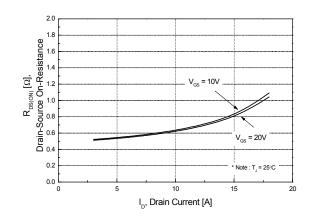
Typical Performance Characteristics

Figure 1. On-Region Characteristics

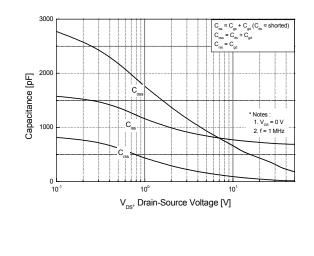
Figure 2. Transfer Characteristics

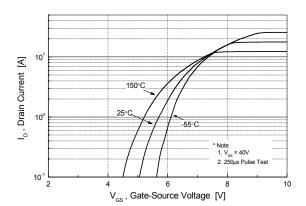




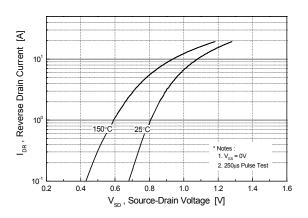


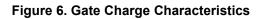


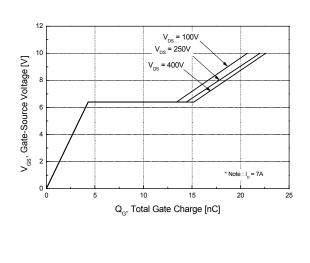


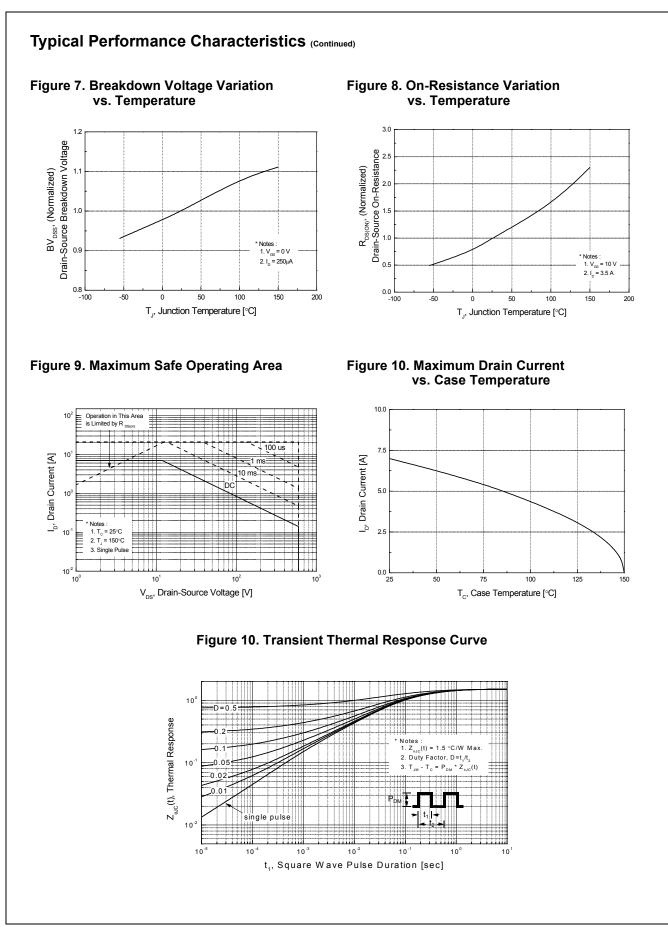




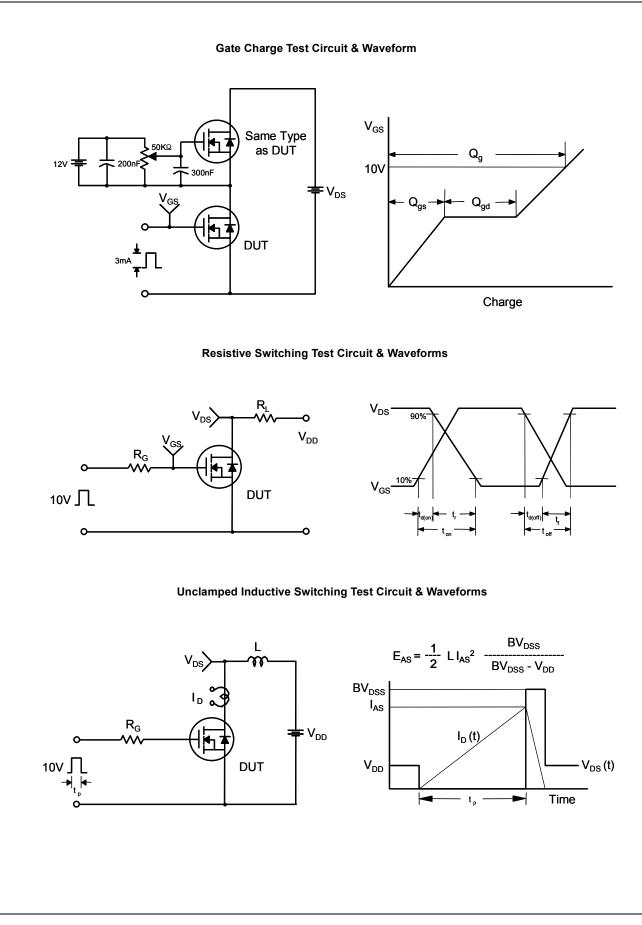






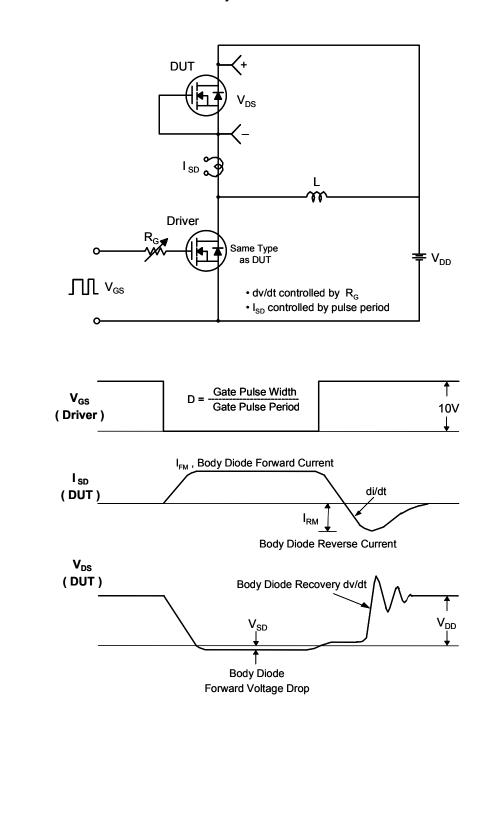


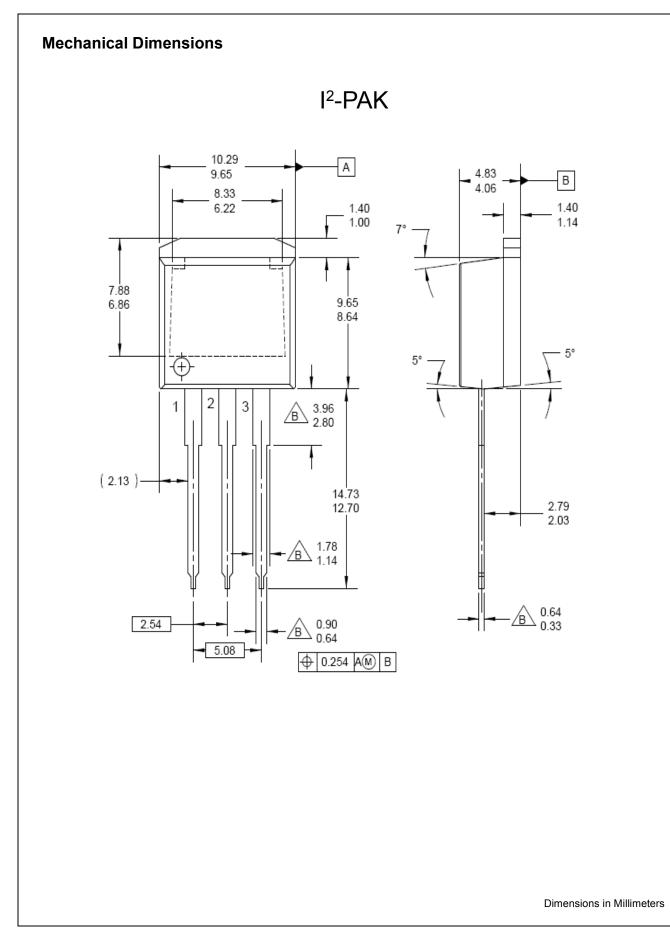
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Peak Diode Recovery dv/dt Test Circuit & Waveforms







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